|                 | <         | SPECIFI         | CATION     | >  |
|-----------------|-----------|-----------------|------------|--|
|                 |           |                 | SPI<br>Dat | EC.No. ASDIQ-SPE-030(00)<br>te: May.17, 2022 |
| То :            |           |                 |            |  |
|                 |           | CUSTOMER'S PRO  | DUCT NAME  |  |
|                 |           | ASDI PRODUCT NA | AME:       | 1  |
|                 |           | SIPM1204A-SERI  | ES         |  |
|                 |           |                 |            | •  |
| RECEIPT CONFIRM |           |                 |            |  |
| UNCOND          | ITIONAL C | ONSENT          | CONDI      | TIONAL CONSENT                               |
|                 | APPR      | OVED            | CHE        | CKED   |
|                 |           |                 |            |  |
| ASDI SIGNATURE  |           |                 |            |  |
| APPR            | OVED      | CHECKED         | PREPARED   | ]  |
|                 | long Li   | Liang Wang      | Jiayin Cai |  |



| REV. | DATE          | DESCRIPTION | APPROVED     | CHECKED    | PREPARED   |
|------|---------------|-------------|--------------|------------|------------|
| 00   | May. 17, 2022 | New release | Xianglong Li | Liang Wang | Jiayin Cai |
|      |               |             |              |            |            |
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|      |               |             |              |            |            |

# **CAUTION WHEN HANDLING**

Before use the products, please read this specification.

## **CAUTION FOR SAFETY USING**

When use the products, be careful to mentioned below for safety using.

## **CAUTION**

\*The product should be used within 12 monthes.

Focus on the storage conditions.

Solderability may become weak if it exceeds the period.

\*Do not use and store the product in condition of gas corrosion

(Salt, Acid, Alkaline).

\*The products must be preheated before soldering.

\*Rework by soldering iron; Please keep the mentioned conditions in this specification.

\*In case of insert P.C. Board on chassis, do not add mechanical stress to the product.

\*Be careful to arrange of non-magnetic field type inductors.

The error may be caused by magnetic field coupling.

\*In case handle the products, please use wrist strap for ground static discharge on human body.

The product keeps away from magnet or magnetized things.

\*Do not use the product beyond the mentioned conditions in this specification.

\*About an application

The products listed on this specification sheet are intended for use in general electronic equipment

(AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

\*The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

1)Aerospace/Aviation equipment
2)Military equipment
3)Seabed equipment
4)Safety equipment
5)Medical equipment
6)Transportation control equipment
7)Power-generation control equipment
which directly endanger human life
8)Atomic energy-related equipment
9)Other applications that are not

considered general-purpose applications

If you intend to use the products in the following applications, please contact our sales office.

Transportation equipment (cars, electric trains, ships, etc.), Public information-processing equipment, Electric heating apparatus / burning equipment, Disaster prevention/crime prevention equipment

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.

DWG.No. ASDIQ-SPE-030(00)

ISSUE

Xiamen ASDI Electronics Co.,Ltd.

| CUSTOMER | ASDI PART No.    | CUSTOMER'S DWG NO. |
|----------|------------------|--------------------|
|          | SIPM1204A-SERIES |                    |

## 1.Applications

Laptops and PCs,Switch and servers,Base stations, DC/DC converters,Battery powered devices.SSD modules.

## 2.INDEX

| Listed item                 | Attachment&Tables | Page |
|-----------------------------|-------------------|------|
| 1.Features                  | Please see (1)    | 3/8  |
| 2.Part Numbering            | Please see (2)    | 3/8  |
| 3.Dimensions                | Please see (3)    | 3/8  |
| 4.Recommend Land Pattern    | Please see (4)    | 3/8  |
| 5.Electrical Specifications | Please see (5)    | 4/8  |
| 6.Structure and Components  | Please see (6)    | 5/8  |
| 7.Reliability Tests         | Please see (7)    | 5/8  |
| 8.Soldering and Mounting    | Please see (8)    | 6/8  |
| 9.Packaging Information     | Please see (9)    | 6/8  |
| 10.Note                     | Please see (10)   | 8/8  |

### 3.Manufacturing Location

China

| DWG.No. | ASDIQ-SPE-030(00) | PAGE<br>2/8 |
|---------|-------------------|-------------|
|---------|-------------------|-------------|

### (1)Features

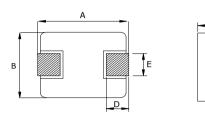
- ·ROHS, Halogen Free and REACH compliance
- High rated current
- ·125℃ maximum total temperature operation
- 13.8×13.3×4.0mm maximum surface mount package
- ·Low core loss
- ·Ultra low buzz noise due to molding construction

#### (2)Part Numbering

SIPM 1204 1R5 M С Ε Α

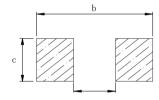
- A: Series
- **B**: Dimension
- C: Material
- D: Inductance 1R5=1.5uH E: Inductance Tolerance M=±20%

#### (3)Dimensions



| A(mm)      | B(mm)      | C(mm)   | D(mm)     | E(mm)       |
|------------|------------|---------|-----------|-------------|
| 13.45±0.35 | 12.80±0.50 | 4.00Max | 2.00±0.50 | See remarks |

#### (4)Recommend Land Pattern



| a typ | b typ | c typ |
|-------|-------|-------|
| 8.0   | 14.5  | 5.5   |

#### Remarks

| series    | E        | Dimensions                                  |
|-----------|----------|---|
|           | 3.85±0.5 | R22/R47                                     |
| SIPM1204A | 5.00±0.3 | R68/R82/1R0/1R5/2R2/3R3/4R7/6R8/100/150/220 |

Marking
The inductor is marked with a 3-digit code

| Nominal Inductance |               |  |
|--------------------|---------------|--|
| Example            | Nominal Value |  |
| 1R0                | 1.0 µH        |  |
| 100                | 10 µH         |  |
| 101                | 100 µH        |  |

Note: Using Ink for marking



| DWG.No. ASDIQ-SPE-030(00) | PAGE<br>3/8 |
|---------------------------|-------------|
|---------------------------|-------------|

Xiamen ASDI Electronics Co.,Ltd.

#### (5)Electrical Specifications Table 1

|                  | Inductance         | DC<br>Resistance | Saturation<br>Current | Heating Rating<br>Current |
|------------------|--------------------|------------------|-----------------------|---------------------------|
| ASDI Part Number | L0(µH)             | DCR (mΩ)         | I sat(A)              | Irms (A)                  |
|                  | ±20%<br>100 KHz/1V | MAX              | TYP.                  | TYP.                      |
| SIPM1204A-R22M   | 0.22               | 0.9              | 50.0                  | 42.0                      |
| SIPM1204A-R47M   | 0.47               | 2.0              | 48.0                  | 33.0                      |
| SIPM1204A-R68M   | 0.68               | 3.5              | 47.0                  | 28.0                      |
| SIPM1204A-R82M   | 0.82               | 4.5              | 40.0                  | 28.0                      |
| SIPM1204A-1R0M   | 1.00               | 7.5              | 35.0                  | 24.0                      |
| SIPM1204A-1R5M   | 1.50               | 9.5              | 30.5                  | 20.0                      |
| SIPM1204A-2R2M   | 2.20               | 11.5             | 26.0                  | 18.0                      |
| SIPM1204A-3R3M   | 3.30               | 13.0             | 21.0                  | 15.0                      |
| SIPM1204A-4R7M   | 4.70               | 14.5             | 18.0                  | 13.0                      |
| SIPM1204A-6R8M   | 6.80               | 20.0             | 14.0                  | 9.0                       |
| SIPM1204A-100M   | 10.0               | 25.0             | 10.0                  | 8.0                       |
| SIPM1204A-150M   | 15.0               | 39.0             | 7.5                   | 6.5                       |
| SIPM1204A-220M   | 22.0               | 51.0             | 6.0                   | 4.5                       |

#### Note:

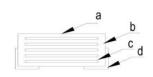
- 1. All test data is referenced to 25 °C ambient
- 2. Operating temperature range 55 °C to + 125 °C
- 3. Irms (A):DC current (A) that will cause an approximate  $\Delta T$  of 40 °C(reference ambient temperature is 25 °C)
- 4. Isat(A):DC current (A) that will cause L0 to drop approximately 30 %
- 5. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions

Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

| DWG.No. | ASDIQ-SPE-030(00) | PAGE<br>4/8 |
|---------|-------------------|-------------|
| Co. Ltd |                   |             |

#### (6)Structure and Components

| Symbol | Components               | Material                   |
|--------|--------------------------|----------------------------|
| а      | Marking                  | Ink (black)                |
| b      | Core Alloy Spongy Powder |                            |
| С      | Wire                     | Polyamideimide copper wire |
| d      | Terminal                 | Copper plated with Sn      |



#### (7)Reliability Tests

|                                | Mechanical Reliability   |  |  |  |  |  |  |  |
|--------------------------------|--------------------------|--|--|--|--|--|--|--|
| No.                            | Test item                | Performance  | Test details   |  |  |  |  |  |
| 1                              | Solderability            | No case deformation or change in apperarance     New solder coverage more than 95% | 1.Preheat: 155℃±5℃, 60S±2S<br>2.Solder: lead-free.<br>3.Temperature: 240℃±5℃,<br>flux 3.0S±0.5S.   |  |  |  |  |  |
| 2                              | Mechanical<br>shock      | 1. No case deformation or change in apperarance<br>2. △L/Lo≦±10%                   | 1. Acceleration: 100G 2. Pulse time:: 6ms 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions  |  |  |  |  |  |
| 3                              | Mechanical<br>vibration  | 1.No case deformation<br>or change in apperarance<br>2. △L/Lo≦±10%                 | 1. Reflow: 2times 2. Frequency: 10HZ~55HZ~10HZ, 20 Min/Cycles 3. Amplitude: 1.52 mm 4. Directions: X,Y,Z 5. Time: 12 cycle / direction   |  |  |  |  |  |
| Endurance and Reliability Test |                          |  |  |  |  |  |  |  |
| No.                            | Test item                | Performance  | Test details   |  |  |  |  |  |
| 4                              | Thermal shock<br>test    | Inductance change:<br>Within ± 10% Without distinct damage in appearance           | <ol> <li>First -55<sup>™</sup> for 30 minutes, last 125</li> <li>for 30 minutes as 1 cycle. Go through 1000 cycles.</li> <li>Max transfer time is 3 minutes.</li> <li>Measured at room temperature after placing for 24±2 hours</li> </ol> |  |  |  |  |  |
| 5                              | Humidity<br>Resistance   | Inductance change:<br>Within ± 10% Without distinct damage in appearance           | 1.Reflow 2 times,<br>2.85 ℃,85%RH,1000 hours<br>3.Measured at room temperature after<br>placing for 24±2 hours   |  |  |  |  |  |
| 6                              | Low temperature storage  | Inductance change:<br>Within ± 10% Without distinct damage in appearance           | 1. Temperature: -55 ± 2°C 2. Time: 1000 hours 3. Measured at room temperature after placing for 24±2 hours   |  |  |  |  |  |
| 7                              | High temperature storage | Inductance change:<br>Within ± 10% Without distinct damage in appearance           | 1. Temperature: +125 ± 2°C 2. Time: 1000 hours 3. Measured at room temperature after placing for 24±2 hours  |  |  |  |  |  |

| 5/8 | DWG.No. ASDIQ-SPE-030(00) PAGE |
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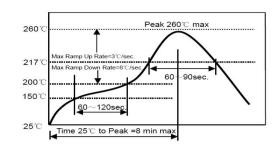
# Recommended Soldering Technologies (8)Soldering and Mounting

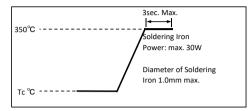
#### 8-1,Re-flowing Profile

- \*Preheat condition: 150 ~200  $^{\circ}$ C/60~120sec. \*Allowed time above 217  $^{\circ}$ C: 60~90sec.
- \*Max temp: 260 ℃
- \*Max time at max temp: 5 sec.
- \*Solder paste: Sn/3.0Ag/0.5Cu \*Allowed Reflow time: 2x max

#### 8-2, Iron Soldering Profile

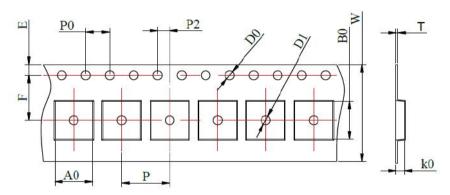
Iron soldering power: Max. 30W Pre-heating: 150℃/60sec. Soldering Tip temperature: 350℃ Max. Soldering time: 3sec. Max. Solder paste: Sn/3.0Ag/0.5Cu Max.1 times for iron soldering





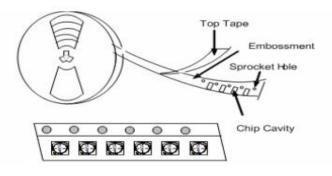
#### (9)Packaging Information

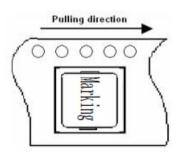
9-1, Tape Packaging Dimensions (Unit: mm)



| Ī | Time      |        |        |         |         | 1       | Γape Dime | nsions (mm) |          |        |         |          |          |
|---|-----------|--------|--------|---------|---------|---------|-----------|-------------|----------|--------|---------|----------|----------|
|   | Туре      | W      | Р      | P0      | P2      | D0      | D1        | Т           | A0       | В0     | K0      | E        | F        |
| ĺ | SIPM1204A | 24±0.3 | 16±0.1 | 4.0±0.1 | 2.0±0.1 | 1.5±0.1 | 1.5±0.1   | 0.5±0.05    | 13.1±0.1 | 14±0.1 | 4.3±0.1 | 1.75±0.1 | 11.5±0.1 |

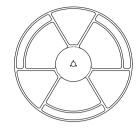
#### Taping Drawings (UNIT:mm)



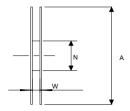


| DWG.No. | ASDIQ-SPE-030(00) | PAGE<br>6/8 |
|---------|-------------------|-------------|
|---------|-------------------|-------------|

#### 9-2,Reel Dimensions(Unit: mm)







| Α       | W        | Ν        | В        | С        |
|---------|----------|----------|----------|----------|
| 330+2.0 | 24.0±0.5 | 97.0±0.5 | 2.20+0.5 | 13.2±0.2 |

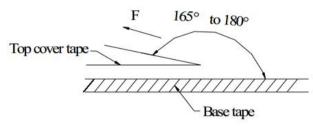
#### 9-3, Packaging Quantity

| T         | Standard Quantity |                        |                               |  |  |
|-----------|-------------------|------------------------|-------------------------------|--|--|
| Туре      | Reel              | Inner box              | Carton box                    |  |  |
| SIPM1204A | 500 pcs / reel    | 2Reel / box (1000 pcs) | 4 Middle boxes,<br>(4000 pcs) |  |  |

#### 9-4,Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N

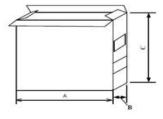


Label

#### 9-5,Reel Label

- ·Label on the reel
- ·Customer's part Number
- ·Lot Number
- ·Quantity
- ·Date code
- ·Shipping Label
- ·Customer's part Number
- ·Manufacturer's part Number
- ·Quantity
- ·Date code

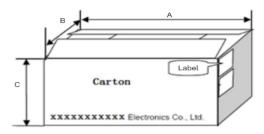
#### 9-6,Inner Box



| Packing Type | A (mm) | B (mm) | C (mm) |
|--------------|--------|--------|--------|
| Inner Box    | 335    | 70     | 340    |

DWG.No. ASDIQ-SPE-030(00) PAGE 7/8

#### 9-7,Carton



| Packing Type | A (mm) | B (mm) | C (mm) |
|--------------|--------|--------|--------|
| Туре         | 360    | 360    | 360    |

#### (10)Note

#### ·Storage Conditions

To maintain the solderability of terminal electrodes:

- 1. ASDI products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Temperature: 5 to 30deg.C, Humidity: 75%
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- ·Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

| DWG.No. | ASDIQ-SPE-030(00) | PAGE<br>8/8 |
|---------|-------------------|-------------|